

	I	2		3	4		
	PRODUCT NO 5 6 POSITIONS	DIM. A DIM.B	NOTES:		PLATING OPTIONS OVER CONTACT AREA		
-	55508-X04 2 X 2 2.	.00 / .079 3.92 / .154	I. HOUSING MAT'L : HIGH	TEMP PLASTIC.	$0 = 0.05 \mu m / 2 \mu'' A u$	-	
	-X06 2X3 4.	.00 / .158 5.92 / .233	2 TERMINAL MAT/L . DUOC		I = 0.76μm/30μ"Au	-	
٨		.00 / .236 7.92 / .312	2. TERMINAL MAT'L : PHOS	PHOR DRONZE.	$3 = 0.38 \mu m / 15 \mu "Au$	-	
A		.00 / .315 9.92 / .391	3. TERMINAL RETENTION 0.	5Kg/l.l Lbs	, ,	-	
-		0.00 / .394 11.92 / .469	4. ´V´ CUT OPTIONAL - MAN	UFACTURING PROCESS	OPTION.		
-							
-		I.00 / .551 I5.92 / .627 5.00 / .630 I7.92 / .706	(5) SOLDER TAILS OF P/N:5	5508-XXX IS IIN/LE	AD PLAIED.		
		B.00 / .709 19.92 / .784	6. SOLDER TAILS OF P/N:5	5508-XXXLF IS 100%	MATTE TIN PLATED.		
-		0.00 / .787 21.92 / .863	7. PRODUCT DESCRIPTION C	ODF :			
-	-X24 2 X I2 22	2.00 / .866 23.92 / .942	X X X X X - X X X L F				
-	- X 2 6 2 X I 3 2 4	1.00 / .945 25.92 / 1.020					
В		.00 / 1.024 27.92 / 1.099		- LEAD FREE (6) (1)			
		.00 / 1.102 29.92 / 1.178		- EXTENSION NUMBER			
-		.00 / 1.181 31.92 / 1.257		BASE NUMBER			
-		.00 / I.260 33.92 / I.335 .00 / I.339 35.92 / I.4I4	8. PACKAGING: (a) XXXXX-XXX	STD PACKAGING	IN THRF		
-		.00 / 1.339 35.92 / 1.414	(b) X X X X X - X X X T R	TAPE AND REEL	PACKAGING		
		.00 / 1.496 39.92 / 1.572	(c) XXXXX-XXXTRN	WITH PICK-UP C TAPE AND REEL	AP (SEE FIG I). Packaging	-	
-		.00 / 1.575 41.92 / 1.650		WITHOUT PICK-U			
-	-X44 2X22 42.	.00 / 1.654 43.92 / 1.729	9. CO-PLANARITY: FROM POSITION - XO4	THRU -X38 : 0.10			
_	- X 4 6 2 X 2 3 4 4 .	.00 / 1.732 45.92 / 1.808	- X4C	THRU - X50 : 0.12	/ .005		
C		.00 / 1.811 47.92 / 1.887	IO.THE HOUSING WILL WITH TEMPERATURE FOR IO SE	STAND EXPOSURE TO	255°C PEAK Ion Infra-red		
Ŭ	-X50 2X25 48.	.00 / 1.890 49.92 / 1.965	OR VAPOR PHASE REFLOW		TON, INFINA NED		
S	(1). THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.						
<u>F</u> 12. A <u>F</u> SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.							
							Copyright
D			2.65 (REF.) [.104] Dr JPEH Eng JPEH Chr KH LEE Aver JOEY, NG	2002-07-19 ANGULAR 2002-07-19 ±2° 2009-08-18 0° 2000 08-18	0.XXX ±.051 ECN \$09-0253	-	
		FIG. I	Appr JOEY NG	2009-08-18 Product	Rev.	-	
		$ \cup . $		LOW PROFILE VCC A Top entry SMT Assy	2.3 55508 F		
	REV F - 2006-04-17			alog no	- CUSTOMER sheet 2 of 2]	
		2		3	PDM: Rev:F STATUS Released Printed: Oct 08, 2009		

		4		
		ING OPTI ACT AREA	ONS OVER	
).05µm/2		_
).76µm/3).38µm/l		
			,	- A
ED.				
tin p	LATED			
				B
NG FIG).			
NG				
EAK				
FRA-R	ЕD			C
ND OT	HER			
EW OR	NOTE			
ING R	EVISIO			
oleran	ce std	projection		-
SO 406 ERWISE SF	ISO IIOI PECIFIED	$\bigoplus - \bigcirc$	MM/INCH	
0.X	±0.3 ±.13	size A 3	Scale 10:1	D
D. XXX	±.051	ECN	S09-0253	_